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(54) Method for curing ultraviolet-curable silicone compositions

(57) There is disclosed herein a method for curing UV-curable silicone compositions, characterized by the formation of cured silicone, having a low-tack surface that is harder than the interior. The cured silicone is pro-

duced by exposing an UV-curable silicone composition to ultraviolet radiation at a ratio of the exposure dose for wavelengths of 200 to 280 nm (excluding 280 nm) to the exposure dose for wavelengths of 280 to 400 nm of 0.5 to 10.0.

Description

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The present invention provides to a method for curing ultraviolet (UV) curable silicone rubber compositions that yield, upon exposure to a particular type of UV radiation, curod silicone having a low-tack surface which is harder than the interior.

UV-curable allicone compositions, which cure rapidly into silicone under UV illumination, are widely used in industrial applications. These compositions are exemplified by JP-A 57-52371; EP 0400785; and U.S. Patent 4,707,503. The irradiation of these silicone compositions with ultraviolet light is carded our using well-known light sources, such as mercury lamps, hydrogen discharge tubes, xenon discharge tubes, motal halide lamps, and so forth.

However, the direct exposure of UV-curable efficience compositions to UV light from these light sources also yields oured silicone with a very tacky surface. This can cause difficult handling, in addition, such surfaces readily pick up dirt and dust, which causes a substantial deterioration in appearance. These problems are particularly acute with lower-hardness cured silicones. For example, when a silicone gel is formed on the surface of an optical semiconductor element using a UV-curable silicone composition, the dust and dirt picked up by the surface will cause a major decline in the performance of the element.

We have performed extensive investigations to solve the above-described problem. As a result, we solve the above-described problem. As a result, we solved that UV fight in the short wavelength region is a major contributor to curing silicone compositions at the surface, We also found that low surface tack cured silicone, whose surface is harder than its interior, is also produced by exposure to UV light at a short wavelength exposure to long wavelength exposure dose ratio within a particular range. Our invention was achieved based on these discoveres.

In specific torms, then, the present invention takes as its object the introduction of a method for curing UV-curable silicone compositions that characteristically produce cured silicone rubbers having a low-tack surface, which is harder than the interior. These rubbers are attained by exposing a UV-curable silicone composition to a particular type of UV radiation.

The method of the present invention is specifically characterized by the formation of curod silicone by exposure of an UV-curable ellipsone composition to ultraviolet radiation at a ratio of the exposure dose for wavelengths of 200 to 200 nm (excluding 280 nm) to the exposure dose for wavelengths of 280 to 400 nm of 0,5 to 10.0.

The nature of the UV-curable silicone composition subjected to the present invention is not crucial. Typical silicone compositions that may be used include, those in which the base ingredient is acrytamide-functional organopolysiloxane, as in JP-A 57-52371 or EP 0400785; and those in which the base ingredients are an organo-

polysiloxane with at least 2 mercaptoalkyl groups in each molecule and an organopolysiloxane with at least 2 alkenyl groups in each molecule, as in U.S. Patent 4,707,509. Other operable UV-curable allicone compositions are those in which the base ingredient is an alkenyl-functional organopolysiloxane; those in which the base ingredient is an ecrylic-functional or methacrylic-functional organopolysiloxane; and those in which the base ingredients are an organopolysiloxane having at least 2 alkenyl groups in each molecule and an organopolysiloxane having at least 2 alkenyl groups in each molecule and an organopolysiloxane having at least 2 alkenyl groups in each molecule. Preferred for the present invention are UV-curable allicone compositions of the adomontioned patents.

The nature of the acrylamide-functional organopolysiloxane is not crucial, and it is exemplified by, but is not limited to: dimethylpolysilorane, endblocked by acrylamidopropyldimethylatoxy at one or both molecular terminale; dimethylpolysiloxane, endblocked by Nmethylacrylamidopropyldimethylsiloxy at one or both molecular terminals; dimethylpotysiloxane, endblocked by acrylamidolsobutyldimethylsiloxy at one or both molocular terminals; dimethylpolysiloxane, endblocked by N-methylacrylamidolsobutyldimethylsiloxy at one or both molecular terminals; dimethylpolysiloxane-methylphonylsiloxane copolymer, endblocked by acrylamidopropyldimethylalloxy at one or both molecular terminals; dimethylsiloxane-methylphenylsiloxane copolymer, endblocked by N-methylacrylamidopropyldimethylsiloxy at one or both molecular terminals; dimethylsiloxene-methylphenylsiloxane copolymer, endblocked by acrylamidoisobutyldimethylsiloxy at one or both molecular terminals; dimethylsiloxane-methylphenylsiloxane copolymer endblocked by N-methylacrylamidoisobutyldimethylstloxy at one or both molecular terminale; dimethylsiloxane-diphenylsiloxane copolymer endblocked by acrylamidopropyldimethylsiloxy at one or both molecular terminals; dimethylelloxane-diphenylelloxane copolymer endblocked by ecrylamidoisobutyklimethyleilaxy at one or both molecular terminale; dimethylsiloxane-methylvinylsiloxane copolymer endblocked by acrylamidapropyldimethylsikary at one or both molecular terminals; dimethylsiloxane-methylvinylsiloxane copolymer endblocked by acrylamidalsobutyldimethylelloxy at one or both molecular terminals; diphenylsiloxane-methylphenylsiloxane copolymer endblocked by acrylamidopropyldiphenylsitoxy at one or both molecular terminals; methylphonylpolysiloxane endblocked by acrylamidopropylmethylphenylsiloxy at one or both molecular terminals; diphenylpolysiloxans endblocked by acrylamidopropyldiphenylsiloxy at one or both molecular terminals; mathylphenylpolysiloxane, endblocked by acrylamidopropyldiphenylsiloxy at only one molecular chain terminal; dimethylpolysilozane bearing acrylamidopropyl in a nonterminal position; dimethylpolysiloxane bearing N-methylacrylamidopropyl in a nonterminal position; dimethylpolysiloxane bearing acrylamidoisobutyl in a nonterminal position; dimethylpolyaliczane bearing N-methylacrylamidoisobutyl in a nonterminal position; dimethylsiticzanemethylphanylaliczana copolymer bearing acrylamidopropyl in a nonterminal position; dimethylaliczane-methylphenyfaliczane copolymer bearing acrylamidolsobutyl in a nonterminal position; dimethylaliczane-methylvinylsiliczane copolymer bearing acrylamidopropyl in a nonterminal position; and dimethylaliczane-methylvinylsiliczane copolymer bearing acrylamidolsobutyl in a nonterminal position. The aforesaid organopolysilozanes may be used singly or as mixtures of two or more selections.

The nature of the mercaptoalkyl-functional organopolysiloxane is also not crucial, and it is exemplified by, but is not limited to: dimethyl(3-mercaptopropyl)siloxyendblocked dimethylpolysiloxane; dimethyl(3-mercaptopropyl)alloxy-endblocked dimethylsiloxane-methylphenylsiloxane copolymer; dimethyl(3-mercaptopropyl) ailoxy-endblocked dimethylsiloxane-diphenylsiloxane copolymer; methyl(3-mercaptopropyl)siloxane-dimethylsiloxane copolymer; methyl(9-mercaptopropyl)siloxane-methylphenylsiloxano copolymor; (3-morcaptopropyl)siloxane-diphenylailoxane copoly-9-mercaptopropyl(phonyl)siloxane-dimothylsiloxane copolymer, and 3-mercaptopropyl(phenyl)siloxane-diphenylailoxane copolymer. These mercaptoalkyl-functional organopolysiloxanas may also be used singly or as mixtures of two or more selections.

The alkenyl-functional organopolysiloxane is exemplified by, but is not limited to; dimethylviny/siloxy-endblocked dimethylpotysiloxane dimethylvlnylsiloxy-endblocked dimethylslloxane-methylphenylsiloxane copoldimethylvinylailoxy-endblocked dimethylsllozane-diphenylailoxane copolymer, dimethylvinylailoxy-enablocked dimethylsiloxane-methylylnylsiloxane copolymer, dimethylvinylslloxy-endblocked dimethyleiloxane-phenylvinylsiloxane copolymer, dimethylvinylsiloxy-endblocked methylvinylpolysiloxane, methylvinylslicazne-dimethylsiloxane copolymor, methylvinylsiioxene-methylphenylsiloxane copolymer, methylvinylsiioxana-diphenylsiloxana copolymer, phenylvinylsiloxane-dimethylsiloxane copolymer, and phenylvinylsiloxane-diphenylelloxane copolymer. These alkerrylfunctional organopolysiloxanes may also be used singly or as mixtures of two or more selections.

While the amount of alkenyl-functional organopolysilozene is not crucial, it is preferably added in a quantity that will give 0.1 to 5.0 moles of alkenyl radical from this organopolysilozane per mole of mercaploalityl radical in the marcaptoalityl-functional organopolysilozane.

Insofar as the object of the invention is not impaired, our UV-curable allicone compositions may also contain a photoinitiator as an optional component. The photoinitiators that may be used are acetophenone and its derivatives, such as dichloroacetophenone, trichloroacetophenone, tert-butyfrichloroacetophenone, 2,2-distinguacetophenone, and p-dimethylaminoacotophenone; benzoin and its derivatives, such as benzoin me-

thyl ether, benzoin ethyl ether, benzoin butyl ether, and benzoin n-buryl ether, benzophenone and its derivatives, such as 2-chlorobenzophenone, p.p'-dichlorobenzophenone, and p.p'-bisdicthylaminobenzophenone; pdimethylaminopropiophenone; Michier's ketone; benzyl; benzyl dimethył ketal; monosulfido; thioxanthone; 2-chlorothioxanthone; 2-methylthioxanthone; azoisobutyranilnile; benzoin peroxide; di-ten-butyl peroxide; l-hydrazycyclohexyl phenyl ketone; 2-hydroxy-2-methyl-1-phenyipropen-1-one; 1-(4-leopropylphenyl)-2-hydroxy-2-methylpropan-1-one; methyl benzoyllomate; diphenyl sulfide; anthracene; 1-chloroanthraquinone; diphonyl disulfide; diacetyl; hexachlorobutadiene; pentachiorobutadiene; octachiorobutadieno; and 1-chioromethylnaphthalene. Particularly preferred photoinitletors are acetophenone, benzoin, benzophenone, and their derivatives. The quantity of photoinklator that may be used in the present invention is not critical. However, the preferred quantity of photoinitiator is 0.1 to 10 weight percent based on the total composition.

Our UV-curable silicone composition may contain, for example, the following as optional components, again insofar as the object of the invention is not impaired; photosensitizers, including n-butylamine, dinbutylamine, tri-n-butylphosphine, allylthicures, S-benzylisothiuronium p-toluenesuffinate, triethylamine, and diethylamineothyl methactylate; inorganic fillers, fumed silica and quariz powder, thermally conductive fillers; including electrically conductive fillers, matals and including matal compounds; pigments; dyes; and organic solvents, such as hoxane, heptane, toluene, and xylene.

The form of the cured silicone afforded by our curing method is not crucial, and the cured silicone may be, for example, a get, rubber, or resin. Gets are preferred because they fully exploit the effects of the present Invention. The viscosity of our UV-curable silicone composition is not crucial, but a viscosity at 25°C from 10 to 100,000 mPa.s (centipoise) is preferred for good handling characteristics of the composition and good physical properties in the cured silicone product.

Our curing method requires that the UV-curable silicone composition be illuminated with ultraviolet light at a ratio of the exposure dose for wavelengths of 200 to 280 nm (excluding 280 nm) to the exposure dose for wavelengths of 280 to 400 nm (hereinafter the shortwavelength to long-wavelength exposure dose ratio or SWED/LWED ratio) of 0,5 to 10.0. The surface of the cured silicono will be extremely tacky when curing is eftected by direct illumination with UV light from known sources (e.g., mercury lamps, hydrogen-discharge tubes, xenon-discharge tubes, and metal halide lamps) with their SWED/LWED ratios below 0.5. At the other end of the range, when UV light is used at a SWED/ LWED ratio in excess of 10.0, the resulting cured silicone will have a very hard surface with a largo number of cracks in its surface. No particular restrictions apply to the specific technique used in our curing mothod to effect exposure to UV light at a SWED/LWED ratio of ومأدي المواذبي

0.5 to 10.0. For example, A UV-cut filter can be used with a conventional light source having a SWED/LWED ratio below 0.5 to adjust the SWED/LWED ratio to 0.5 to 10.0.

With regard to the use of conventional light sources in our curing method, UV-cut filters are available commercially for adjusting the SWED/LWED ratio of said conventional light sources to 0.5 to 10.0. Stacks of these filters may also be used. Afternatively, direct exposure to UV light from a conventional source may be used, while at the same time effecting exposure to UV light from a conventional source that has been passed through a UV-cut filter. As another atternative, these two types of exposure can be carried out sequentially rathor than simultaneously. The exposure dose at 280 to 400 nm and the exposure dose at 200 to 280 (excluding 280 nm) irradiated on the UV-curable silicone composition can be readily determined using an ultraviolet dose meter or similar device.

The conditions under which our UV-curable silicone composition is exposed to UV light are not critical for our curing method. For example, the composition can be irradiated in the air, under a vacuum, or in an inen gas (e.g., nitrogen, argon, and helium) at room temperature, while cooling, or while heating to 50°C to 150°C. Irradiation in air at room temperature is particularly preferred.

Our curing method produces cured ellicone whose surface is harder than its interior. More particularly, this method produces silicone gel having a tack-free silicone rubber ekin at its surface. As a result of these features, this curing method is useful for the formation of protective coatings on the surface of semiconductor elements; for the formation of conformal coatings on the surface of electronic circuit substrates; for the formation of print patterna; and the like. Our curing method is especially useful for the surface formation on semiconductor elements of silicone gel which presents a tack-free silicone subbor ekin that is recipied to the adhesion of dirt and dust.

The method according to the present invention for curing UV-curable ellicone compositions will be explained in greater detail through working examples. The viscosity values reported in the examples were measured at 25°C. To evaluate the status of the curre at the surface and in the interior of the curred ellicone, the UV-curable ellicone composition was east on an aluminum dish to a thickness of approximately 5 mm. After exposure to UV light, the curred ellicone was removed from the aluminum dish, and both the surface and the interior of the curred ellicone were inspected by touch.

Example 1

A UV-curable silicone composition was prepared by mbding 2 weight parts of 2-hydroxy-2-methyl-1-phanyl-propen-1-one to homogeneity into 100 weight parts of dimethylsiloxane-methylphenylsiloxane copolymer, endblocked at one molecular terminal with N-methylaci-

ytamidobutyldimethylellory and endblocked at the other terminal with trimethylelloxy. The viacoety, at 25 °C, of the copolymer was 9000 mPa.s (centipolse). The molar ratio of dimethyleiloxane to methylphenyleiloxane in the copolymer was 10:1.

This composition was directly irradiated with UV light from a high-pressure mercury temp while being simultaneously irradiated with UV light from a high-pressure mercury temp that had been passed through a UV-cut filter. The product was a silicone gel having a low-tack silicone rubber skin at the surface. This elficone gel was produced using an exposure dose of 3 J/cm² for the 260 to 400 nm wavelengths and an exposure dose of 4.8 J/cm² for the 200 to 280 nm wavelengths (excluding 280 nm).

Example 2

The following were mixed to homogeneity to give a UV-curable ellicone composition; 8 weight parts of trimethylelloxy-endblocked dimethylelloxane-3-mercaptopropyl(mothyl)siloxane copolymer [viscosity = 100 mPa.s (centipolse), mercapto group content = 4.0 weight%], 100 weight parts of dimethylvinylelloxy-endblocked dimethylpolysiloxane [viscosity = 2,000 mPa.s (centipolse), vinyl content = 0.23 weight%], and 1 weight part of 1-(4-isopropylphenyl)-2-hydroxy-2-methylpropan-1-one.

This UV-curable silicone composition was directly irradiated with UV light from a high-pressure mercury tamp while being elmultaneously irradiated with UV light from a high-pressure mercury tamp that had been passed through a UV-cut filter. The product was a silicone gel having a low-tack silicone rubber skin at the surface, This silicone gel was produced using an exposure dose of 0.5 J/cm² for the 280 to 400 nm wavelengths and an exposure dose of 0.8 J/cm² for the 200 to 280 nm wavelengths (osciuding 290 nm).

Comparative Example 1

Direct exposure of the UV-curable silicone composition prepared in Example 1 with UV light from a high-pressure mercury lamp produced a cilicone gel having a very tacky and soft allicone rubber skin at its surface. This silicone gel was produced using an exposure dose of 3 J/cm² for the 280 to 400 nm wavelengthe and an exposure dose of 1.2 J/cm² for the 200 to 280 nm wavelengths (excluding 280 nm).

Comparative Example 2

The UV-curable silicone composition prepared in Example 1 was directly irradiated with UV light from a high-prossure mercury lamp and thereafter irradiated with UV light from a high-pressure mercury lamp that had been passed through a UV-cut filter. The product was a silicone gel having a hard silicone resin skin st the surface. This ellicone get was produced using an exposure dose of 3 J/cm² for the 280 to 400 nm wavelengths and an exposure dose of 40 J/cm² for the 200 to 280 nm wavelengths (excluding 280 nm). Numerous cracks were also observed in the silicone resin skin.

Comparative Example S

Direct exposure of the UV-curable silicone composition prepared in Example 2 with UV light from a highpressure mercury lamp produced a silicone get having a very tacky and soft silicone rubber skin at its surface. This silicone get was produced using an exposure dose of 0.5 J/cm² for the 280 to 400 nm wavelengths and an exposure dose of 0.2 J/cm² for the 200 to 280 nm wavelengths (excluding 280 nm).

The method according to the present invention for curing UV-curable efficene compositions characteristically comprises exposing a UV-curable efficiene composition to ultraviolet light at a ratio of the exposure dose for wavelengths of 200 to 200 nm (excluding 280 nm) to the exposure dose for wavelengths of 280 to 400 nm of 0.5 to 10.0. As a result, our method can produce a low surface tack cured silicone whose surface is harder than its interior.

Cisima

- A method for curing UV-curable silicons compositions, comprising the step of exposing an UV-curable silicons composition to ultraviolet radiation having an exposure dose ratio of 0,5 to 10.0, wherein the exposure dose ratio is the exposure dose for the wavelengths from 200 nm up to, but not including 260 nm, divided by the exposure dose for the wavelengths from 280 nm to 400 nm.
- The method of claim 1, wherein the UV-curable sliicone composition yields, upon cure, a silicone get having a silicone rubber covering at its surface.
- The method of claim 1, wherein the UV-curable sillone composition comprises an acrylamide-functional organopolysilloxane.
- 4. The method of claim 1, whorein the UV-curable sliicone composition comprises A) an organopolysiloxane having at least 2 mercaptoslikyl groups in each molecule, and B) an organopolysitoxane having at least 2 alientyl groups in each molecule, in a quantity that provides 0.1 to 5 moles of alientyl group per mole of mercaptoslikyl group.

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EUROPEAN SEARCH REPORT

Applicates Number EP 96 38 1095

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